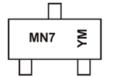


Marking Information



 $\begin{array}{l} \mathsf{MN7} = \mathsf{Product Type Marking Code} \\ \mathsf{YM} = \mathsf{Date Code Marking} \\ \mathsf{Y or } \overline{\mathsf{Y}} = \mathsf{Year (ex: I = 2021)} \\ \mathsf{M} = \mathsf{Month (ex: 9 = September)} \end{array}$

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	I	J	K	L	М	Ν	0	Р	R	S	Т	U
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 5) V_{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	ID	2.5 2.0	А
Continuous Drain Current (Note 6) V_{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	ID	3.3 2.7	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t≦10sec	T _A = +25°C T _A = +70°C	ID	3.8 3.1	A
Continuous Drain Current (Note 6) V_{GS} = 4.5V State T_A = +25°C T_A = +70°C			ID	2.7 2.1	А
Pulsed Drain Current (Note 7)			I _{DM}	25	А

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	PD	0.74	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	173.4	°C/W
Total Power Dissipation (Note 6)	PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	99.1	°C/W
Total Power Dissipation (Note 6) t \leq 10sec	PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 6) t \leq 10sec	R _{0JA}	72	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Notes:

Device mounted on FR-4 PCB, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, on 1inch square copper plate
 Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%



Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						•
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current @T _C = +25°	C I _{DSS}	-	-	1.0	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	IGSS	-	-	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	1.0	-	3.0	V	V_{DS} = V_{GS} , I_D = 250 μ A
Static Drain-Source On-Resistance	D	-	54	73	mΩ	V _{GS} = 10V, I _D = 3.1A
	R _{DS (ON)}	-	88	110		V_{GS} = 4.5V, I_{D} = 2A
Forward Transfer Admittance	Y _{fs}	-	4.8	-	mS	V _{DS} = 10V, I _D = 3.1A
Diode Forward Voltage (Note 6)	V _{SD}	-	0.75	1.0	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	-	305.8	-	pF	
Output Capacitance	C _{oss}	-	39.9	-	pF	─V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	39.5	-	pF	
Gate Resistance	Rg	-	1.4	-	Ω	V_{DS} = 0V, V_{GS} = 0V,f = 1.0MHz
Total Gate Charge (V_{GS} = 4.5V)	Qg	-	4.1	-	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	-	8.6	-	nC	$V_{GS} = 10V, V_{DS} = 10V,$
Gate-Source Charge	Q _{gs}	-	1.2	-	nC	$-I_D = 3A$
Gate-Drain Charge	Q _{gd}	-	1.5	-	nC	
Turn-On Delay Time	t _{D(on)}	-	2.6	-	ns	
Turn-On Rise Time	tr	-	4.6	-	ns	V _{DD} = 15V, V _{GS} = 10V,
Turn-Off Delay Time		-	13.1	-	ns	$R_L = 47\Omega, R_G = 3\Omega,$
Turn-Off Fall Time	t _{D(off)}	-	2.5	-	ns	

Notes: 8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



25°C

-55°C

4

5

T_A = 150°C

T_∧ = 85°C

T_A = 25°C

TA -55°C

V_{GS}=4.5V I_D=5A

V_{GS}=10V

125

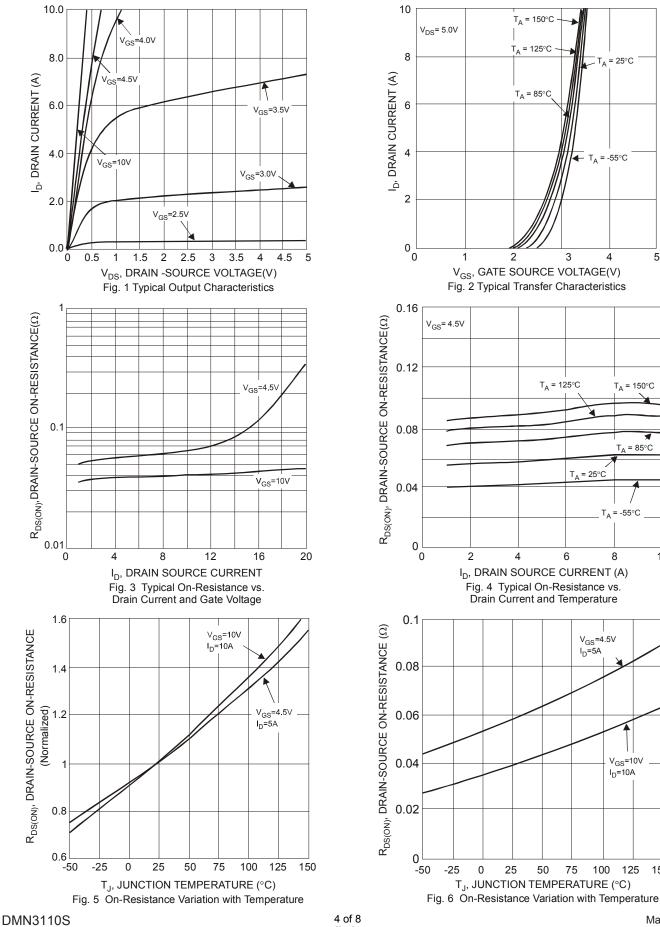
I_D=10A

100

8

10

Τ_Α



Document number: DS31561 Rev. 4 - 2

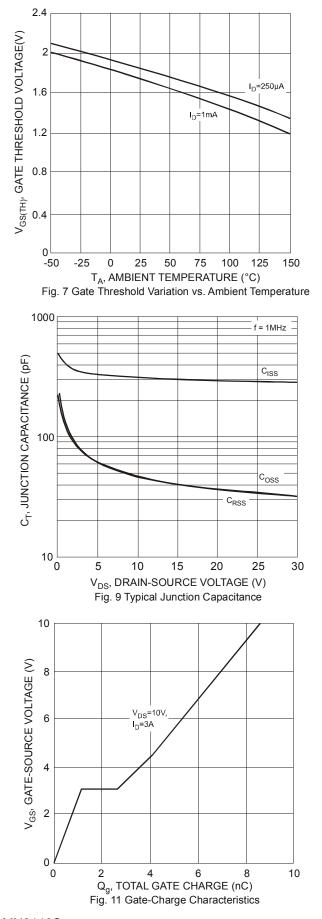
Downloaded from Arrow.com.

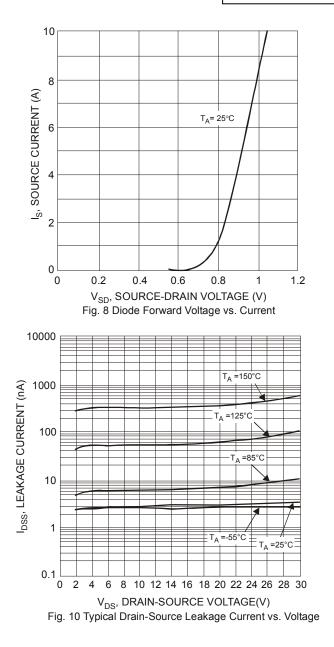
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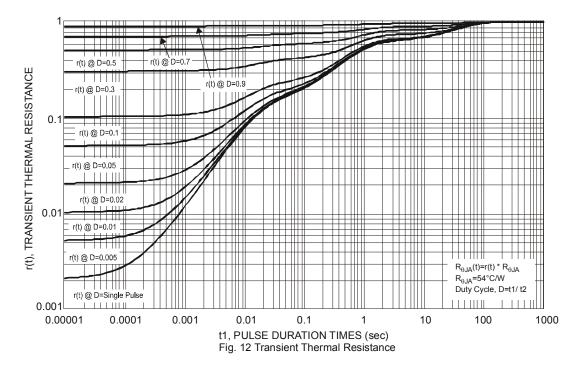
150







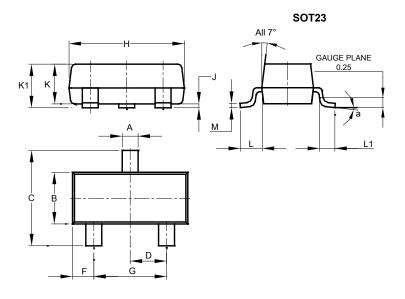






Package Outline Dimensions

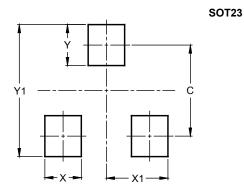
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
ĸ	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



 Dimensions
 Value (in mm)

 C
 2.0

 X
 0.8

 X1
 1.35

 Y
 0.9

 Y1
 2.9



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